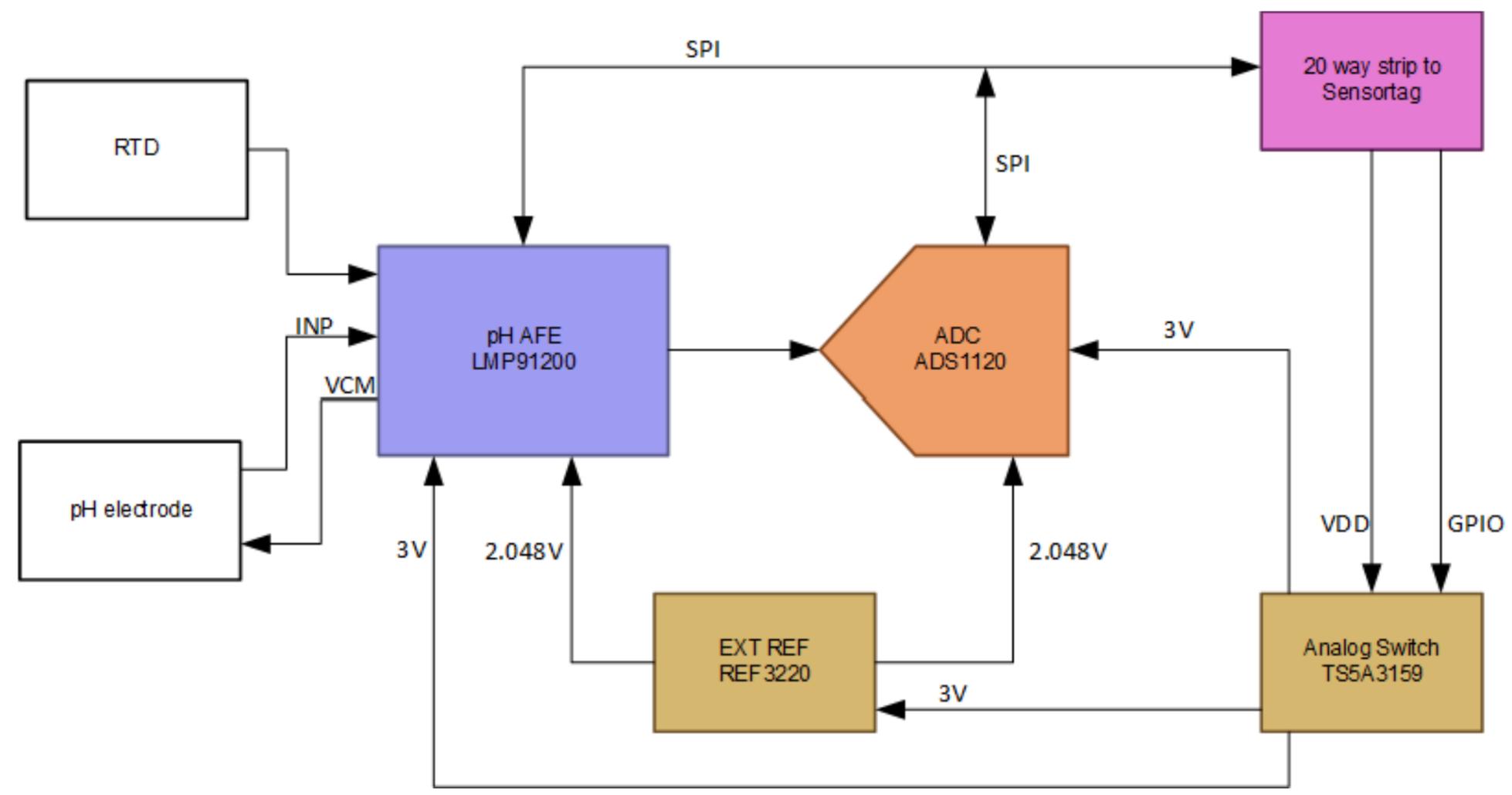


Revision History	
Revision	Notes

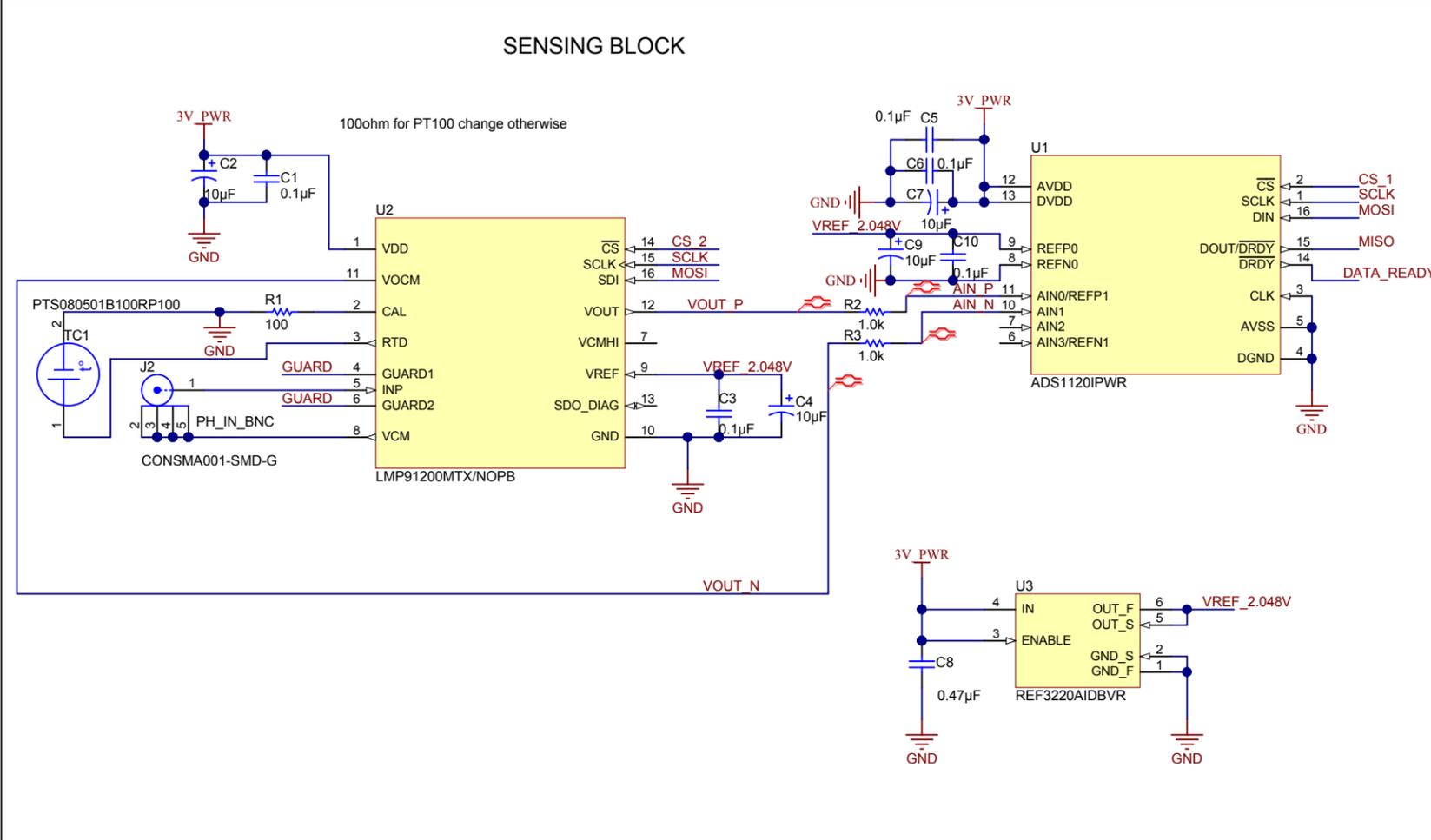
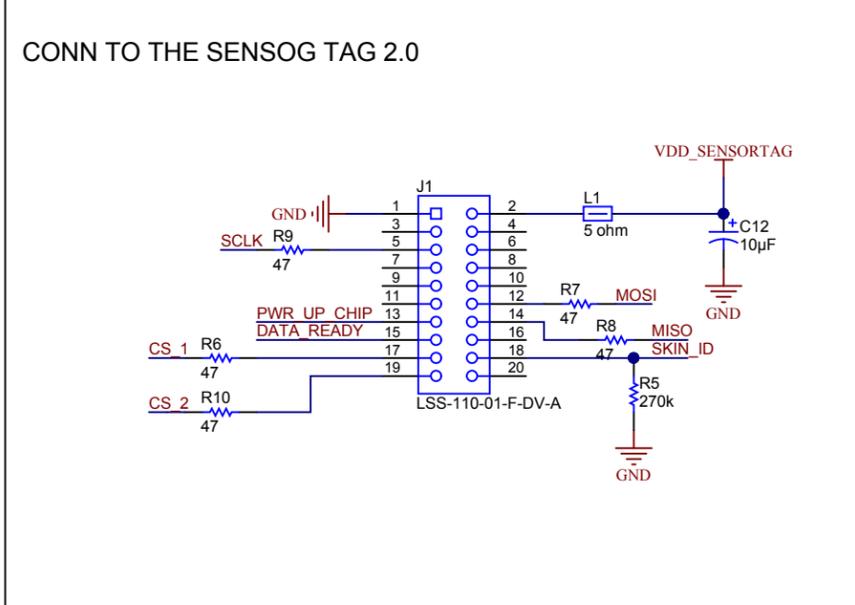
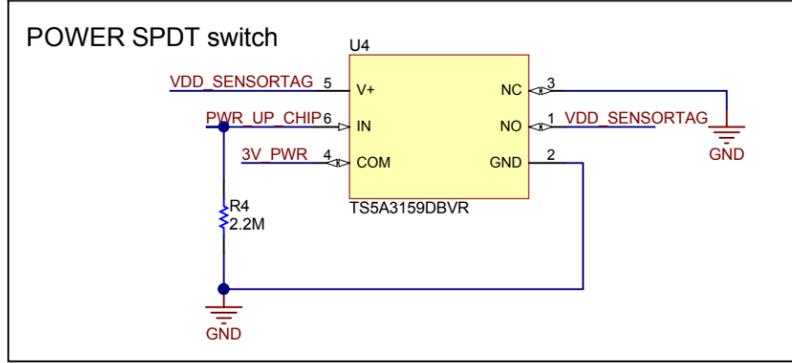


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Orderable: EVM_orderable	Designed for: Public Release	Mod. Date: 6/16/2015
TID #: TIDA-00561	Project Title: Wireless PH Sensor	
Number: TIDA-00561	Rev: E1	Sheet Title: Block Diagram
SVN Rev: Version control disabled	Assembly Variant: 001	Sheet: 1 of 3
Drawn By: Giovanni Campanella	File: TIDA-00561_CoverSheet_SchDoc	Size: B
Engineer: Giovanni Campanella	Contact: http://www.ti.com/support	



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Label Table	
Variant	Label Text
001	ISTA-EVM-00561
002	ChangeMe!

PCB Number: TIDA-00561
PCB Rev: E1

PCB LOGO
[Texas Instruments](#)

PCB LOGO
Pb-Free Symbol

PCB LOGO
FCC disclaimer

LBL1
PCB Label
Size: 0.65" x 0.20"

ZZ1
Label Assembly Note
This Assembly Note is for PCB labels only

ZZ2
Assembly Note
These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ3
Assembly Note
These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ4
Assembly Note
These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

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